

# PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT								
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT								
<b>CONVEYING PARTY DATA</b>									
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Won-Tae KIM</td> <td>01/14/2011</td> </tr> <tr> <td>Sung-Ho AHN</td> <td>01/14/2011</td> </tr> <tr> <td>Pil-Je CHO</td> <td>01/14/2011</td> </tr> </tbody> </table>		Name	Execution Date	Won-Tae KIM	01/14/2011	Sung-Ho AHN	01/14/2011	Pil-Je CHO	01/14/2011
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<b>Name:</b>	Samsung Electronics Co., Ltd.								
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;"><b>Name:</b></td> <td>Seneka Co., Ltd.</td> </tr> <tr> <td><b>Street Address:</b></td> <td>1034-4, Yeongtong-Dong, Yeongtong-Gu</td> </tr> <tr> <td><b>City:</b></td> <td>Suwon-Si, Gyeonggi-Do</td> </tr> <tr> <td><b>State/Country:</b></td> <td>REPUBLIC OF KOREA</td> </tr> </table>		<b>Name:</b>	Seneka Co., Ltd.	<b>Street Address:</b>	1034-4, Yeongtong-Dong, Yeongtong-Gu	<b>City:</b>	Suwon-Si, Gyeonggi-Do	<b>State/Country:</b>	REPUBLIC OF KOREA
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<b>PROPERTY NUMBERS Total: 1</b>									
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<b>Application Number:</b>	13014016								
<b>CORRESPONDENCE DATA</b>									
<p>Fax Number: (201)226-9246</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 201-226-9245</p> <p>Email: jeryl.bizzoco@chareiter.com</p> <p>Correspondent Name: Cha &amp; Reiter, LLC</p> <p>Address Line 1: 17 Arcadian Avenue</p> <p>Address Line 2: Suite 208</p> <p>Address Line 4: Paramus, NEW JERSEY 07652</p>									
<b>ATTORNEY DOCKET NUMBER:</b>	5000-1-1307								

CH \$40.00 13014016

**501417532**

**PATENT**  
**REEL: 025699 FRAME: 0383**

NAME OF SUBMITTER:

Steve Cha

Total Attachments: 2

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**Assignment of Invention and Patent Application**

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of TEN (\$10.00) DOLLAR,

- 1) Won-Tae KIM of  
#304-2001, Dongsuwon LG Village 3-cha Xi Apt., Mangpo-dong, Yeongtong-gu,  
Suwon-si, Gyeonggi-do, Republic of Korea
- 2) Sung-Ho AHN of  
#401, Yeowon Artvill, 456-3, Dogok 2-dong, Gangnam-gu, Seoul, Republic of Korea
- 3) Pil-Je CHO of  
#1001-2402, Yeongtong Tranchae APT., 707, Mangpo-dong, Yeongtong-gu,  
Suwon-si, Gyeonggi-do, Republic of Korea

(hereinafter **Assignors**) hereby sells, assigns, transfers, and sets over unto:

**SAMSUNG ELECTRONICS CO., LTD.** of  
**416, MAETAN-DONG, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO, 442-742,**  
**REPUBLIC OF KOREA**

**SENEKA CO., LTD.** of  
**1034-4, YEONGTONG-DONG, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO,**  
**REPUBLIC OF KOREA**

(hereinafter **Assignee**) the entire right, title and interest for the United States Of America as defined in 35 U.S.C. §1.00, in and to the invention entitled as:

**SWING-TYPE PORTABLE COMMUNICATION APPARATUS AND HINGE MECHANISM THEREOF**

invented by **Assignor**; the application for United States patent therefor, invented by **Assignor**; any patent or reissues of any patent that may be granted thereon; and any applications which are continuations, continuation-in-part, substitutes, or divisions of said application. **Assignor** authorizes **Assignee** to enter the date of signature and/or Serial Number and Filing Date in the above. **Assignor** also authorizes and requests the Commissioner of Patents and Trademarks to issue any resulting patent(s) to the said **Assignee**, for its interests as **Assignee**, its successors, assigns and legal representatives. The undersigned agrees that the attorney of record in said application shall hereafter act on behalf of said **Assignee**; and **Assignor** further conveys to **Assignee** all priority rights resulting from the above-identified application for United States Patent. **Assignor** agrees to execute all papers, give any required testimony and perform other lawful acts, as deemed essential by **Assignee** to perfect **Assignee's** interest in any resulting patent of the United States, and to acquire, hold, enforce, convey, and uphold the validity of said patent and reissues and extensions thereof, and **Assignee's** interest therein.

**SIGNED ON THE DATES(S) INDICATED BESIDE MY/OUR SIGNATURE(S):**

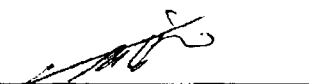
**Name of First Inventor:** Won-Tae KIM

  
\_\_\_\_\_  
Signature of inventor

Dated: Jan. 14, 2011

WITNESSED: \_\_\_\_\_

**Name of Second Inventor:** Sung-Ho AHN

  
\_\_\_\_\_  
Signature of inventor

Dated: Jan. 14, 2011

WITNESSED: \_\_\_\_\_

**Name of Third Inventor:** Pil-Je CHO

  
\_\_\_\_\_  
Signature of inventor

Dated: Jan. 14, 2011

WITNESSED: \_\_\_\_\_